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## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

First Named Inventor: CHRIS WYLAND  
Application No.: 10/537,666 Conf.:  
Date Filed: 6/6/2005

Docket No.: US02 0512 US  
Art Unit: 2811  
Examiner: AJAY ARORA

Title: HIGH DENSITY PACKAGE INTERCONNECT WIRE BOND STRIP LINE AND METHOD THEREFOR

Commissioner for Patents  
P.O. Box 1450  
Arlington, VA 22313-1450

**TRANSMITTAL LETTER**

Sir:

There are a total of 27 pages in this submission which includes this transmittal letter, as well as the documents listed below:

- Response and Amendment - 12 pages
- Information Disclosure Statement Transmittal - 2 page
- IDS references - 13 pages

The Commissioner is hereby requested and authorized pursuant to 37 CFR §1.136(a)(3), to treat any concurrent or future reply in this application requiring a petition for extension of time for its timely submission, as incorporating a petition for extension of time for the appropriate length of time. Please charge any additional fees which may now or in the future be required in this application, including extension of time fees, but excluding the issue fee unless explicitly requested to do so, and credit any overpayment, to Deposit Account No. 14-1270.

Date: 31-JUL-2006

Respectfully submitted,

By Peter Zawilski  
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**CERTIFICATE OF MAILING or TRANSMISSION**

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage for first class mail in an envelope addressed to "Commissioner for Patents, P.O. Box 1450, Arlington, VA 22313-1450," or facsimile transmitted to the USPTO at (571) 273-8300, on the date indicated below.

(Date) 7/31/06(Signature)  
(Name)

Villmaina Naga